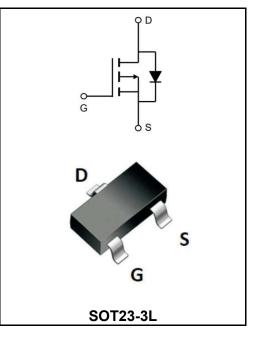


### **P-Channel Enhancement MOSFET**

### **Features**

- VDS (V) =-30V
- ID =-4.2 A (VGS =-10V)
- $RDS(ON) < 60m \Omega$  (Vgs =-10V)
- $RDS(ON) < 65m \Omega$  (VGS =-4.5V)
- Rds(on) < 120m  $\Omega$  (Vgs =-2.5V)



Marking Code				
AO3401	B1H			

## Absolute Maximum Ratings (Ta=25℃)

Parameter	Symbol	Rating	Unit	
Drain-Source Voltage	Vds	-30	V	
Gate-Source Voltage	Vgs	±12	v	
Continuous Drain Current Ta = $25^{\circ}$ C	D	-4.2		
Ta = 70℃	U	-3.5	А	
Pulsed Drain Current	DM	-30		
Power Dissipation Ta = $25^{\circ}$ C	PD	1.4	w	
Ta = 70℃	FD	1	vv	
Thermal Resistance.Junction- to-Ambient t $\leqslant$ 10s	RthJA	90		
Thermal Resistance.Junction- to-Ambient	T T T T T T T T T T T T T T T T T T T	125	°C/W	
Thermal Resistance.Junction- to-Case	RthJC	60		
Junction Temperature	TJ	150	ĉ	
Junction and Storage Temperature Range	Tstg	-55 to 150	C	





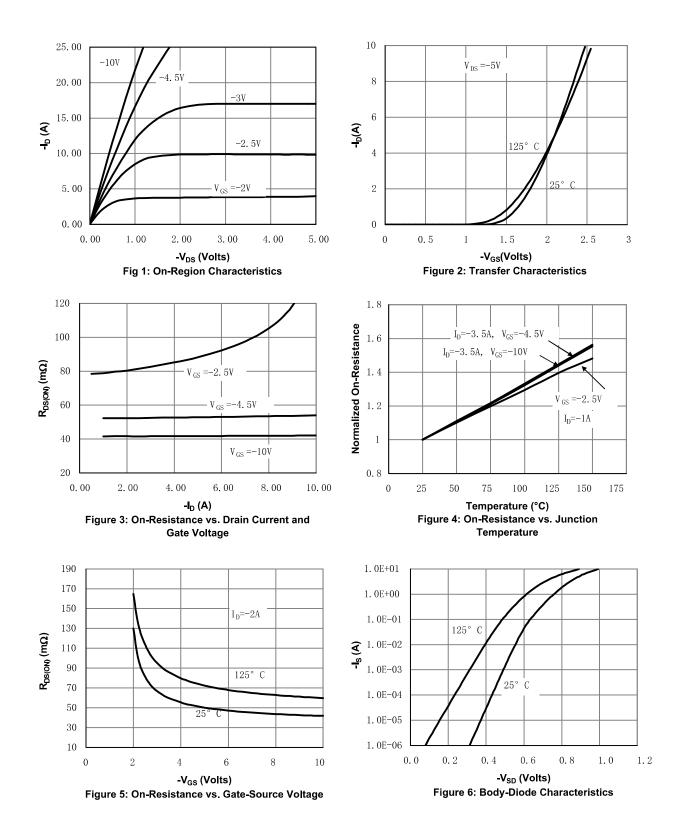
## Electrical Characteristics (Ta=25℃ unless otherwise specified.)

Parameter	Symbol	Test Conditions	Min	Тур	Max	Unit	
Drain-Source Breakdown Voltage	VDSS	ID=-250 µ A, VGS=0V	-30			V	
Zero Gate Voltage Drain Current		VDS=-24V, VGS=0V			-1		
	DSS	VDs=-24V, VGs=0V, TJ=55°C			-5	μA	
Gate-Body leakage current	IGSS	VDS=0V, VGS=±12V			±100	nA	
Gate Threshold Voltage	VGS(th)	VDS=VGS ID=-250 µ A	-0.7	-1	-1.3	V	
Static Drain-Source On-Resistance	R⊡s(On)	VGS=-10V, ID=-4.2A		52	60		
		VGs=-10V, ID=-4.2A TJ=125°C			75		
		VGS=-4.5V, ID=-4A		60	65	mΩ	
		VGs=-2.5V, ID=-1A		75	120		
On state drain current	D(ON)	VGS=-4.5V, VDS=-5V	-25			А	
Forward Transconductance	gFS	VDS=-5V, ID=-5A	4	8		S	
Input Capacitance	Ciss			954			
Output Capacitance	Coss	VGS=0V, VDS=-15V, f=1MHz		115		pF	
Reverse Transfer Capacitance	Crss			77			
Gate resistance	Rg	VGS=0V, VDS=0V, f=1MHz		6		Ω	
Total Gate Charge	Qg	VGS=-4.5V, VDS=-15V, ID=-4A		9.4		nC	
Gate Source Charge	Qgs			2			
Gate Drain Charge	Qgd			3			
Turn-On DelayTime	td(on)			6.3			
Turn-On Rise Time	tr	VGS=-10V, VDS=-15V, RL=3.6 Ω ,RGEN=6 Ω		3.2		ns	
Turn-Off DelayTime	td(off)			38.3			
Turn-Off Fall Time	tf			12			
Body Diode Reverse Recovery Time	trr	IF=-4A, dı/dt=100A/ µ s		20.2			
Body Diode Reverse Recovery Charge	Qrr	IF=5A, dI/dt=100A/ µ s		11.2		nC	
Maximum Body-Diode Continuous Current	ls				-2.2	А	
Diode Forward Voltage	VSD	Is=-1A,VGS=0V		-0.75	-1	V	





### **Typical Characteristics**





### **Typical Characteristics**

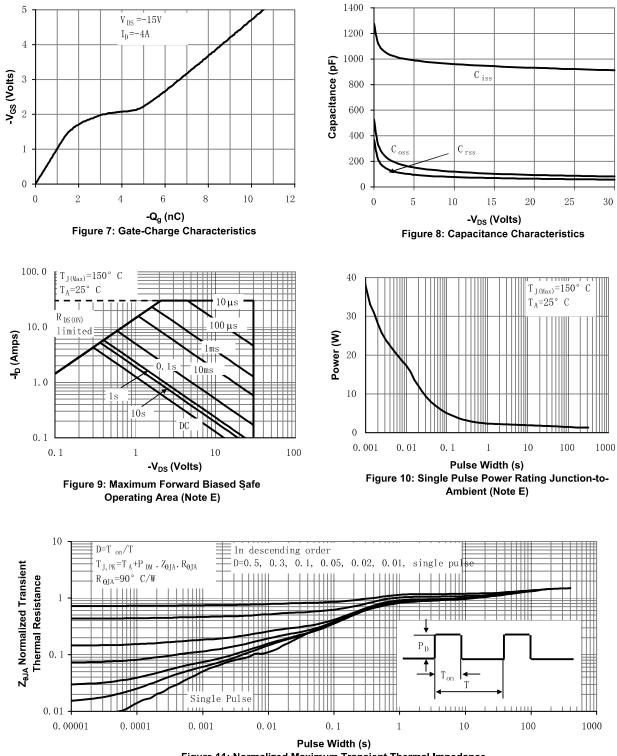


Figure 11: Normalized Maximum Transient Thermal Impedance

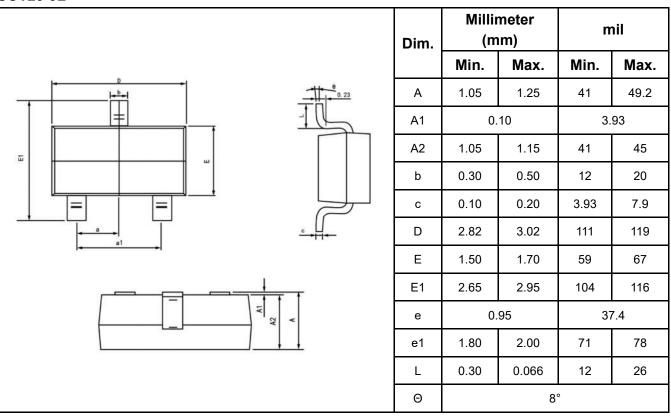
# YFU 佑风微

### **Ordering information**

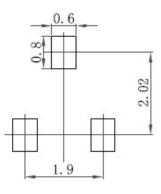
Package	Packing Description	Base Quantity	Packing Quantity
SOT23-3L	Tape/Reel,7"reel	3000pcs/Reel	24000PCS/Box 120000PCS/Carton

## Package Dimensions

## SOT23-3L



## The recommended mounting pad size





# Disclaimer

The information presented in this document is for reference only. GuangDong Youfeng Microelectronics Co.,Ltd. reserves the right to make changes without notice for the specification of the products displayed herein to improve reliability, function or design or otherwise. The product listed herein is designed to be used with ordinary electronic equipment or devices, and not designed to be used with equipment or devices which require high level of reliability and the malfunction of with would directly endanger human life (such as medical instruments, transportation equipment, aerospace machinery, nuclear-reactor controllers, fuel controllers and other safety devices),YFW or anyone on its behalf, assumes no responsibility or liability for any damages resulting from such improper use of sale. This publication supersedes & replaces all information previously supplied. For additional information, please visit our website <a href="https://www.yfwdiode.com">https://www.yfwdiode.com</a>, or consult YFW sales office for further assistance.